

74HC590

8-bit binary counter with output register; 3-state

Rev. 4 — 14 March 2022

Product data sheet

1. General description

The 74HC590 is an 8-bit binary counter with a storage register and 3-state outputs. The storage register has parallel (Q0 to Q7) outputs. The binary counter features master reset counter (\overline{MRC}) and count enable (\overline{CE}) inputs. The counter and storage register have separate positive edge triggered clock (CPC and CPR) inputs. If both clocks are connected together, the counter state is always one count ahead of the register. Internal circuitry prevents clocking from the clock enable. A ripple carry output (\overline{RCO}) is provided for cascading. Cascading is accomplished by connecting \overline{RCO} of the first stage to \overline{CE} of the second stage. Cascading for larger count chains can be accomplished by connecting \overline{RCO} of each stage to the counter clock (CPC) input of the following stage. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

2. Features and benefits

- Wide supply voltage range from 2.0 V to 6.0 V
- CMOS low power dissipation
- High noise immunity
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Complies with JEDEC standards:
 - JESD8C (2.7 V to 3.6 V)
 - JESD7A (2.0 V to 6.0 V)
- CMOS input levels
- Counter and register have independent clock inputs
- Counter has master reset
- Multiple package options
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101C exceeds 1000 V
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

3. Ordering information

Table 1. Ordering information

| Type number | Package | | | |
|-------------|-------------------|----------|--|----------|
| | Temperature range | Name | Description | Version |
| 74HC590D | -40 °C to +125 °C | SO16 | plastic small outline package; 16 leads; body width 3.9 mm | SOT109-1 |
| 74HC590PW | -40 °C to +125 °C | TSSOP16 | plastic thin shrink small outline package; 16 leads; body width 4.4 mm | SOT403-1 |
| 74HC590BQ | -40 °C to +125 °C | DHVQFN16 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 × 3.5 × 0.85 mm | SOT763-1 |

4. Functional diagram

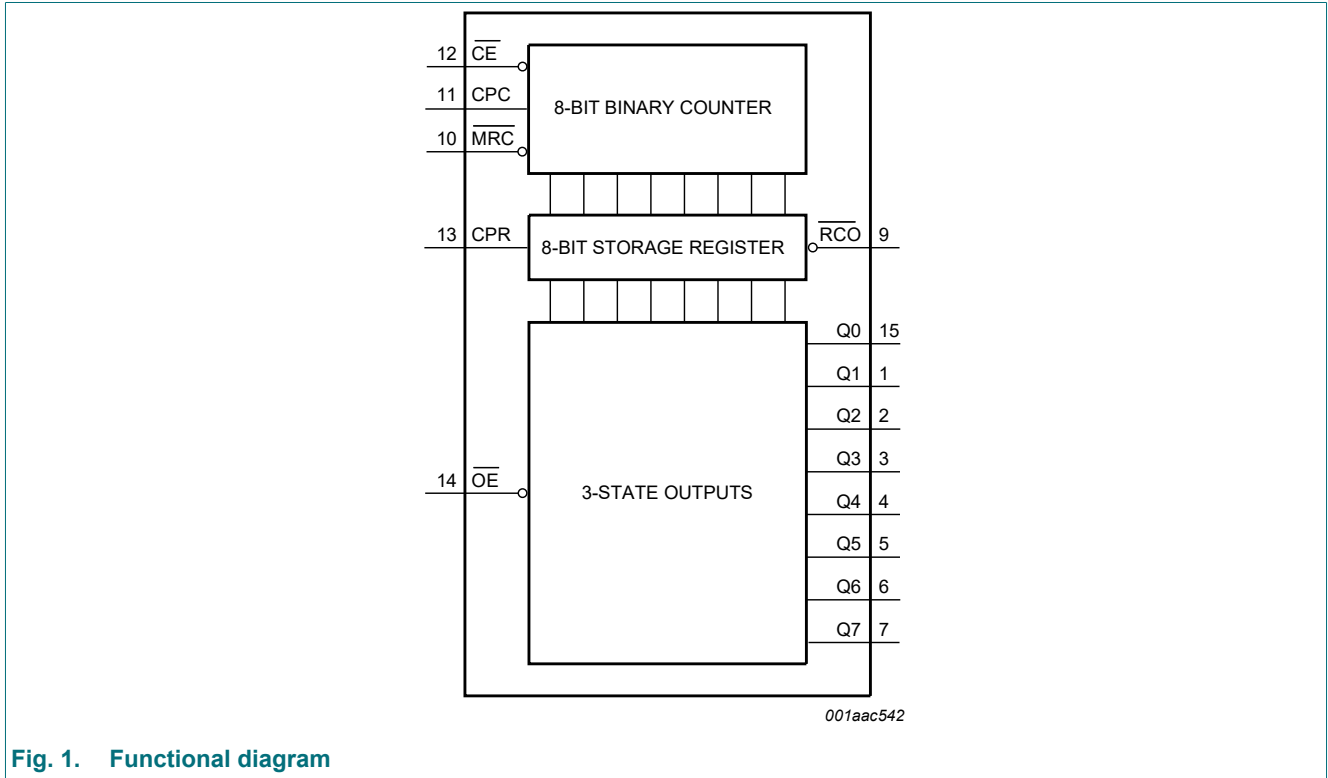


Fig. 1. Functional diagram

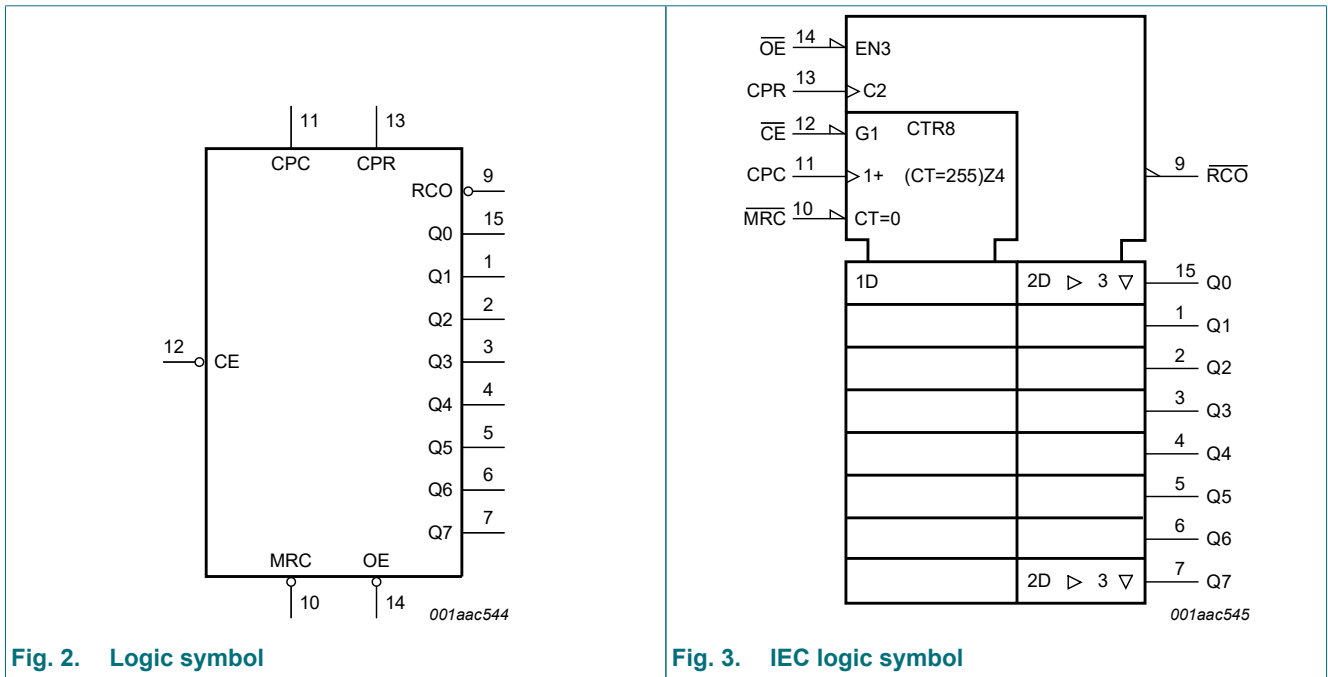


Fig. 2. Logic symbol

Fig. 3. IEC logic symbol

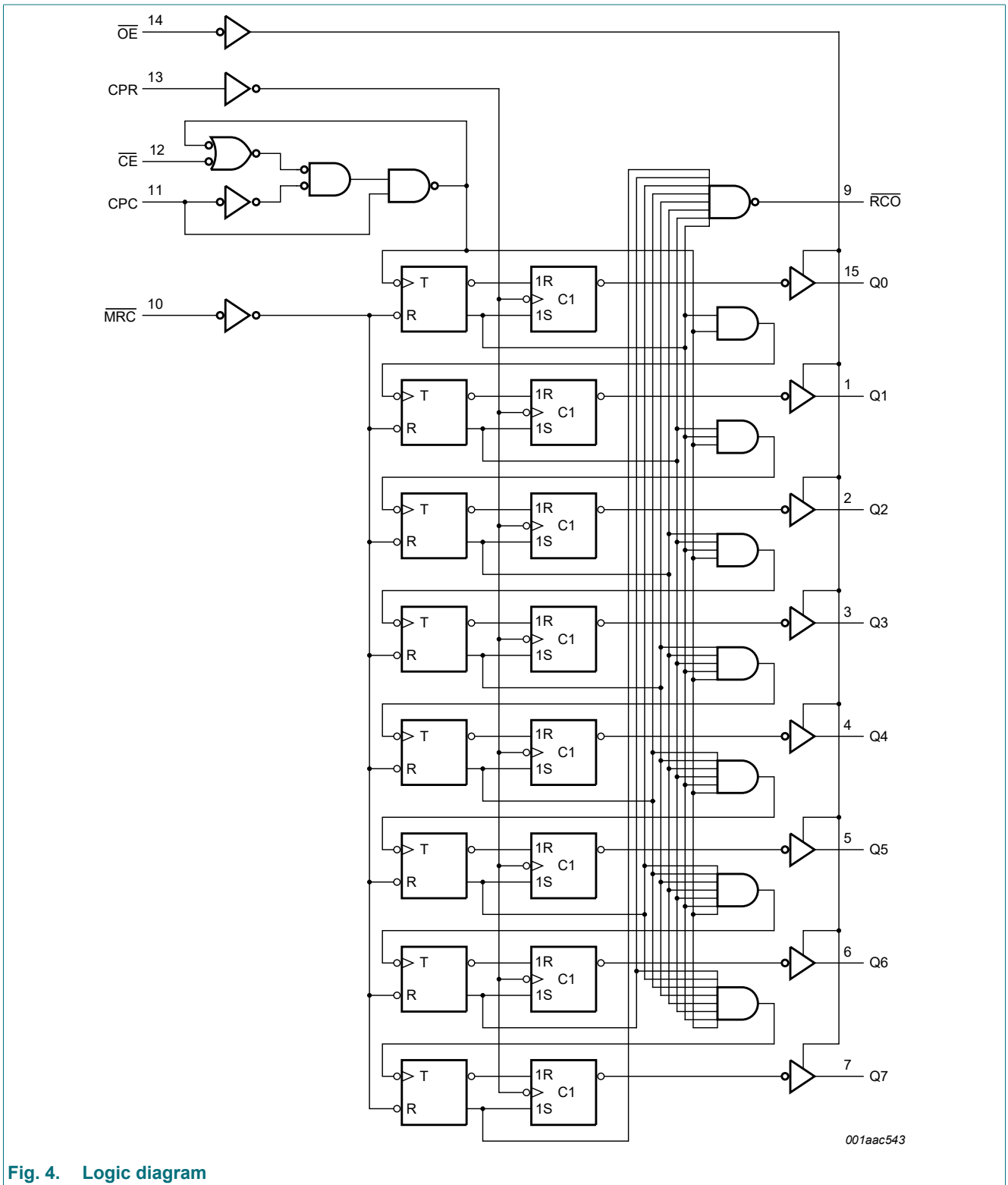
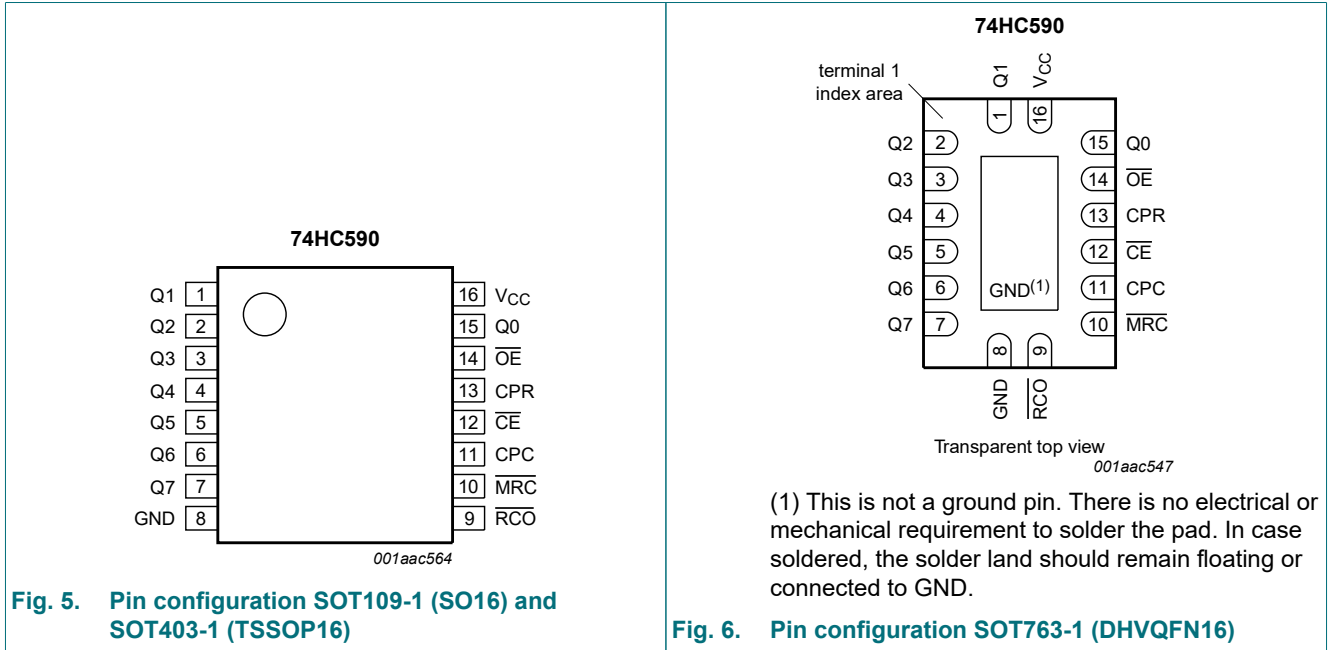


Fig. 4. Logic diagram

5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|--------------------------------|-------------------------|---|
| Q0, Q1, Q2, Q3, Q4, Q5, Q6, Q7 | 15, 1, 2, 3, 4, 5, 6, 7 | parallel data output |
| GND | 8 | ground (0 V) |
| RCO | 9 | ripple carry output (active LOW) |
| MRC | 10 | master reset counter input (active LOW) |
| CPC | 11 | counter clock input (active HIGH) |
| CE | 12 | count enable input (active LOW) |
| CPR | 13 | register clock input (active HIGH) |
| OE | 14 | output enable input (active LOW) |
| V _{CC} | 16 | supply voltage |

6. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care; ↑ = LOW-to-HIGH transition; ↓ = HIGH-to-LOW transition.
 $\overline{RCO} = \overline{Q0} \cdot \overline{Q1} \cdot \overline{Q2} \cdot \overline{Q3} \cdot \overline{Q4} \cdot \overline{Q5} \cdot \overline{Q6} \cdot \overline{Q7}$ ($Q0'$ to $Q7'$ are internal outputs of the counter).

| Inputs | | | | | Description |
|--------|-----|-----|----|-----|-----------------------------------|
| OE | CPR | MRC | CE | CPC | |
| H | X | X | X | X | Q outputs disable |
| L | X | X | X | X | Q outputs enable |
| X | ↑ | X | X | X | counter data stored into register |
| X | ↓ | X | X | X | register stage is not changed |
| X | X | L | X | X | counter clear |
| X | X | H | L | ↑ | advance one count |
| X | X | H | L | ↓ | no count |
| X | X | H | H | X | no count |

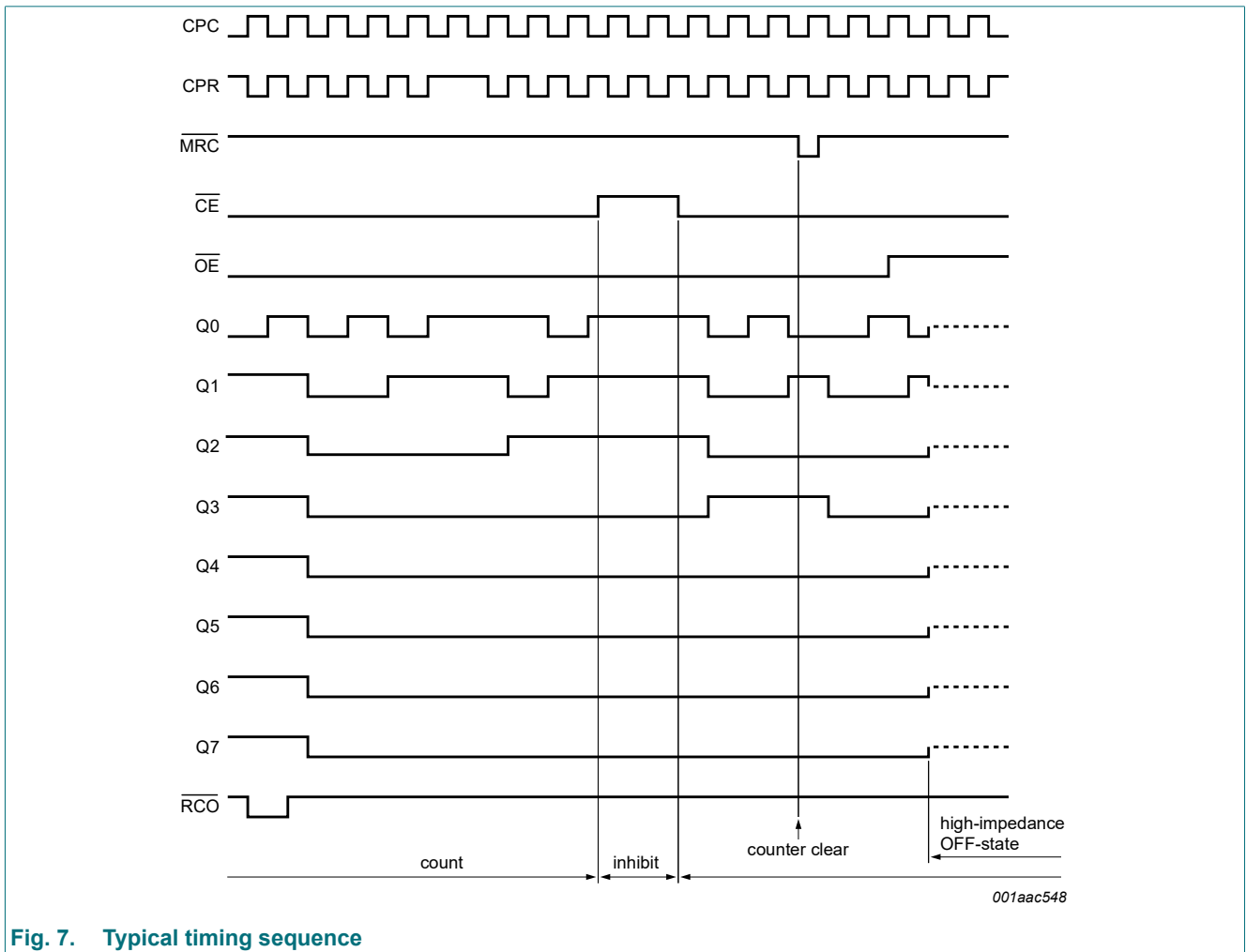


Fig. 7. Typical timing sequence

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|-------------------------|--|------|----------|------|
| V_{CC} | supply voltage | | -0.5 | +7.0 | V |
| I_{IK} | input clamping current | $V_I < -0.5\text{ V}$ or $V_I > V_{CC} + 0.5\text{ V}$ [1] | - | ± 20 | mA |
| I_{OK} | output clamping current | $V_O < -0.5\text{ V}$ or $V_O > V_{CC} + 0.5\text{ V}$ [1] | - | ± 20 | mA |
| I_O | output current | $V_O = -0.5\text{ V}$ to $V_{CC} + 0.5\text{ V}$ | | | |
| | | RCO standard output | - | ± 25 | mA |
| | | Qn bus driver output | - | ± 35 | mA |
| I_{CC} | supply current | | - | 70 | mA |
| I_{GND} | ground current | | -70 | - | mA |
| T_{stg} | storage temperature | | -65 | +150 | °C |
| P_{tot} | total power dissipation | $T_{amb} = -40\text{ °C}$ to $+125\text{ °C}$ [2] | - | 500 | mW |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SOT109-1 (SO16) package: P_{tot} derates linearly with 12.4 mW/K above 110 °C.

For SOT403-1 (TSSOP16) package: P_{tot} derates linearly with 8.5 mW/K above 91 °C.

For SOT763-1 (DHVQFN16) package: P_{tot} derates linearly with 11.2 mW/K above 106 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---------------------|-------------------------------------|-------------------------|-----|------|----------|------|
| V_{CC} | supply voltage | | 2.0 | 5.0 | 6.0 | V |
| V_I | input voltage | | 0 | - | V_{CC} | V |
| V_O | output voltage | | 0 | - | V_{CC} | V |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 2.0\text{ V}$ | - | - | 625 | ns/V |
| | | $V_{CC} = 4.5\text{ V}$ | - | 1.67 | 139 | ns/V |
| | | $V_{CC} = 6.0\text{ V}$ | - | - | 83 | ns/V |
| T_{amb} | ambient temperature | | -40 | - | +125 | °C |

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | 25 °C | | | -40 °C to +85 °C | | -40 °C to +125 °C | | Unit |
|---|---------------------------|---|-------|------|------|------------------|------|-------------------|------|------|
| | | | Min | Typ | Max | Min | Max | Min | Max | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 2.0 V | 1.5 | 1.2 | - | 1.5 | - | 1.5 | - | V |
| | | V _{CC} = 4.5 V | 3.15 | 2.4 | - | 3.15 | - | 3.15 | - | V |
| | | V _{CC} = 6.0 V | 4.2 | 3.2 | - | 4.2 | - | 4.2 | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 2.0 V | - | 0.8 | 0.5 | - | 0.5 | - | 0.5 | V |
| | | V _{CC} = 4.5 V | - | 2.1 | 1.35 | - | 1.35 | - | 1.35 | V |
| | | V _{CC} = 6.0 V | - | 2.8 | 1.8 | - | 1.8 | - | 1.8 | V |
| V _{OH} | HIGH-level output voltage | V _I = V _{IH} or V _{IL} all outputs | | | | | | | | |
| | | I _O = -20 μA; V _{CC} = 2.0 V | 1.9 | 2.0 | - | 1.9 | - | 1.9 | - | V |
| | | I _O = -20 μA; V _{CC} = 4.5 V | 4.4 | 4.5 | - | 4.4 | - | 4.4 | - | V |
| | | I _O = -20 μA; V _{CC} = 6.0 V | 5.9 | 6.0 | - | 5.9 | - | 5.9 | - | V |
| | | \overline{RCO} standard output | | | | | | | | |
| | | I _O = -4 mA; V _{CC} = 4.5 V | 4.18 | 4.31 | - | 4.13 | - | 4.1 | - | V |
| | | I _O = -5.2 mA; V _{CC} = 6.0 V | 5.68 | 5.80 | - | 5.63 | - | 5.6 | - | V |
| | | Qn bus driver output | | | | | | | | |
| | | I _O = -6.0 mA; V _{CC} = 4.5 V | 4.18 | 4.31 | - | 4.13 | - | 4.1 | - | V |
| I _O = -7.8 mA; V _{CC} = 6.0 V | 5.68 | 5.80 | - | 5.63 | - | 5.6 | - | V | | |
| V _{OL} | LOW-level output voltage | V _I = V _{IH} or V _{IL} all outputs | | | | | | | | |
| | | I _O = 20 μA; V _{CC} = 2.0 V | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | I _O = 20 μA; V _{CC} = 4.5 V | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | I _O = 20 μA; V _{CC} = 6.0 V | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | \overline{RCO} standard output | | | | | | | | |
| | | I _O = 4 mA; V _{CC} = 4.5 V | - | 0.17 | 0.26 | - | 0.33 | - | 0.4 | V |
| | | I _O = 5.2 mA; V _{CC} = 6.0 V | - | 0.18 | 0.26 | - | 0.33 | - | 0.4 | V |
| | | Qn bus driver output | | | | | | | | |
| | | I _O = 6.0 mA; V _{CC} = 4.5 V | - | 0.17 | 0.26 | - | 0.33 | - | 0.4 | V |
| I _O = 7.8 mA; V _{CC} = 6.0 V | - | 0.18 | 0.26 | - | 0.33 | - | 0.4 | V | | |
| I _I | input leakage current | V _I = V _{CC} or GND; V _{CC} = 6.0 V | - | - | ±0.1 | - | ±1.0 | - | ±1.0 | μA |
| I _{OZ} | OFF-state output current | V _I = V _{IH} or V _{IL} ; V _O = V _{CC} or GND; V _{CC} = 6.0 V | - | - | ±0.5 | - | ±5.0 | - | ±10 | μA |
| I _{CC} | supply current | V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 6.0 V | - | - | 4.0 | - | 40 | - | 80 | μA |
| C _I | input capacitance | | - | 3.5 | - | - | - | - | - | pF |

10. Dynamic characteristics

Table 7. Dynamic characteristics

GND (ground = 0 V); for test circuit see Fig. 14.

| Symbol | Parameter | Conditions | 25 °C | | | -40 °C to +85 °C | | -40 °C to +125 °C | | Unit |
|------------------|-------------------------------|--|-------|-----|-----|------------------|-----|-------------------|-----|------|
| | | | Min | Typ | Max | Min | Max | Min | Max | |
| t _{pd} | propagation delay | CPC to \overline{RCO} ; see Fig. 8 [1] | | | | | | | | |
| | | V _{CC} = 2.0 V | - | 52 | 150 | - | 190 | - | 230 | ns |
| | | V _{CC} = 4.5 V | - | 19 | 30 | - | 38 | - | 45 | ns |
| | | V _{CC} = 6.0 V | - | 15 | 26 | - | 33 | - | 40 | ns |
| | | CPR to Qn; see Fig. 9 | | | | | | | | |
| | | V _{CC} = 2.0 V | - | 50 | 140 | - | 175 | - | 210 | ns |
| | | V _{CC} = 4.5 V | - | 17 | 28 | - | 35 | - | 42 | ns |
| | | V _{CC} = 6.0 V | - | 14 | 24 | - | 30 | - | 36 | ns |
| t _{PLH} | LOW to HIGH propagation delay | \overline{MRC} to \overline{RCO} ; see Fig. 10 | | | | | | | | |
| | | V _{CC} = 2.0 V | - | 53 | 130 | - | 165 | - | 200 | ns |
| | | V _{CC} = 4.5 V | - | 18 | 26 | - | 33 | - | 40 | ns |
| | | V _{CC} = 6.0 V | - | 14 | 22 | - | 28 | - | 34 | ns |
| t _{en} | enable time | \overline{OE} to Qn; see Fig. 11 [2] | | | | | | | | |
| | | V _{CC} = 2.0 V | - | 28 | 105 | - | 130 | - | 160 | ns |
| | | V _{CC} = 4.5 V | - | 13 | 21 | - | 26 | - | 32 | ns |
| | | V _{CC} = 6.0 V | - | 11 | 18 | - | 22 | - | 27 | ns |
| t _{dis} | disable time | \overline{OE} to Qn; see Fig. 11 [3] | | | | | | | | |
| | | V _{CC} = 2.0 V | - | 28 | 105 | - | 130 | - | 160 | ns |
| | | V _{CC} = 4.5 V | - | 13 | 21 | - | 26 | - | 32 | ns |
| | | V _{CC} = 6.0 V | - | 11 | 18 | - | 22 | - | 27 | ns |
| t _w | pulse width | CPC and CPR; HIGH or LOW; see Fig. 8 and Fig. 9 | | | | | | | | |
| | | V _{CC} = 2.0 V | 100 | 24 | - | 125 | - | 145 | - | ns |
| | | V _{CC} = 4.5 V | 20 | 9 | - | 25 | - | 29 | - | ns |
| | | V _{CC} = 6.0 V | 17 | 8 | - | 21 | - | 25 | - | ns |
| | | \overline{MRC} ; LOW; see Fig. 10 | | | | | | | | |
| | | V _{CC} = 2.0 V | 75 | 28 | - | 95 | - | 110 | - | ns |
| | | V _{CC} = 4.5 V | 15 | 8 | - | 19 | - | 22 | - | ns |
| | | V _{CC} = 6.0 V | 13 | 6 | - | 16 | - | 19 | - | ns |
| t _{su} | set-up time | CPC to CPR; see Fig. 13 | | | | | | | | |
| | | V _{CC} = 2.0 V | 100 | 46 | - | 125 | - | 150 | - | ns |
| | | V _{CC} = 4.5 V | 20 | 14 | - | 25 | - | 30 | - | ns |
| | | V _{CC} = 6.0 V | 17 | 10 | - | 21 | - | 26 | - | ns |
| | | \overline{CE} to CPC; see Fig. 12 | | | | | | | | |
| | | V _{CC} = 2.0 V | 100 | 44 | - | 125 | - | 150 | - | ns |
| | | V _{CC} = 4.5 V | 20 | 11 | - | 25 | - | 30 | - | ns |
| | | V _{CC} = 6.0 V | 17 | 9 | - | 21 | - | 26 | ns | |

8-bit binary counter with output register; 3-state

| Symbol | Parameter | Conditions | 25 °C | | | -40 °C to +85 °C | | -40 °C to +125 °C | | Unit |
|------------------|-------------------------------|---|-------|-----|-----|------------------|-----|-------------------|-----|------|
| | | | Min | Typ | Max | Min | Max | Min | Max | |
| t _h | hold time | CE to CPC; see Fig. 12 | | | | | | | | |
| | | V _{CC} = 2.0 V | 0 | - | - | 0 | - | 0 | - | ns |
| | | V _{CC} = 4.5 V | 0 | - | - | 0 | - | 0 | - | ns |
| | | V _{CC} = 6.0 V | 0 | - | - | 0 | - | 0 | - | ns |
| t _{rec} | recovery time | MRC to CPC; see Fig. 10 | | | | | | | | |
| | | V _{CC} = 2.0 V | 75 | 28 | - | 95 | - | 110 | - | ns |
| | | V _{CC} = 4.5 V | 15 | 7 | - | 19 | - | 22 | - | ns |
| | | V _{CC} = 6.0 V | 13 | 6 | - | 16 | - | 19 | - | ns |
| f _{max} | maximum frequency | CPC or CPR; see Fig. 8 and Fig. 9 | | | | | | | | |
| | | V _{CC} = 2.0 V | 6.6 | 16 | - | 5.2 | - | 4.4 | - | MHz |
| | | V _{CC} = 4.5 V | 33 | 52 | - | 26 | - | 22 | - | MHz |
| | | V _{CC} = 6.0 V | 39 | 61 | - | 31 | - | 26 | - | MHz |
| C _{PD} | power dissipation capacitance | V _I = GND to V _{CC} [4] | - | 44 | - | - | - | - | - | pF |

[1] t_{pd} is the same as t_{PHL} and t_{PLH}.

[2] t_{en} is the same as t_{PZH} and t_{PZL}.

[3] t_{dis} is the same as t_{PLZ} and t_{PHZ}.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

f_i = input frequency in MHz;

f_o = output frequency in MHz;

C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

∑(C_L × V_{CC}² × f_o) = sum of outputs.

10.1. Waveforms and test circuit

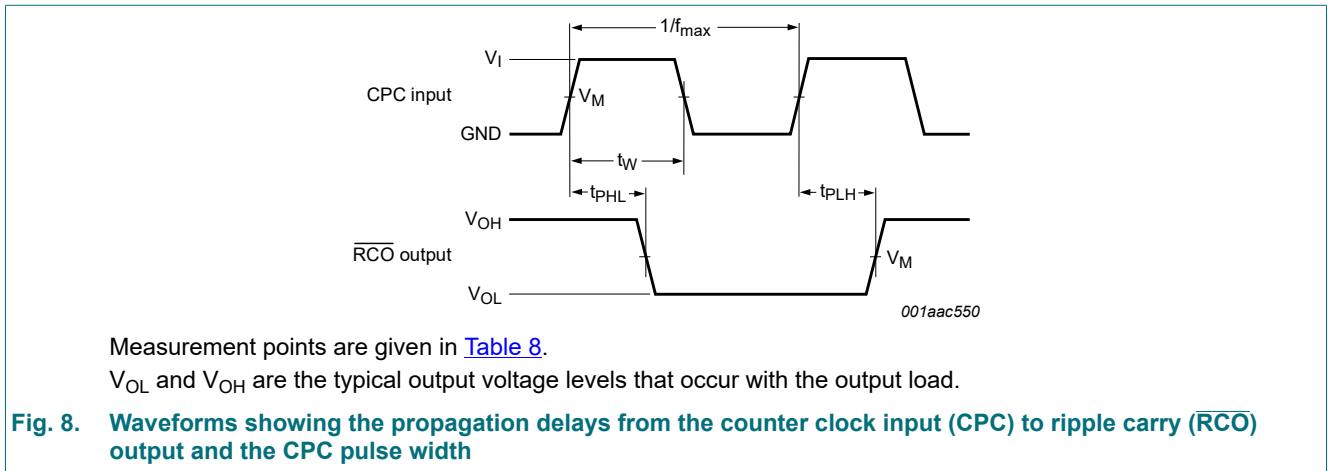
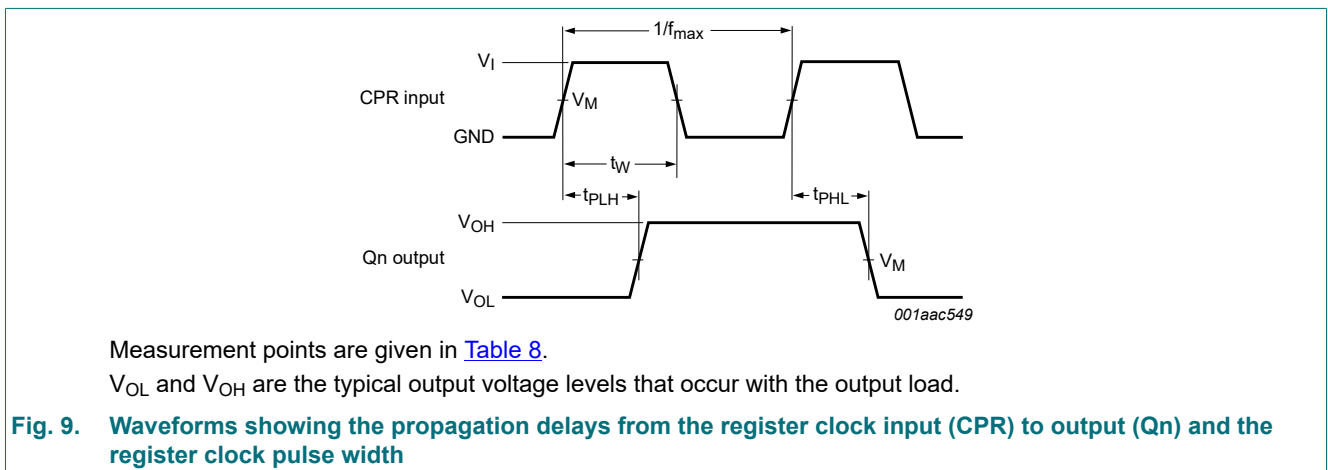
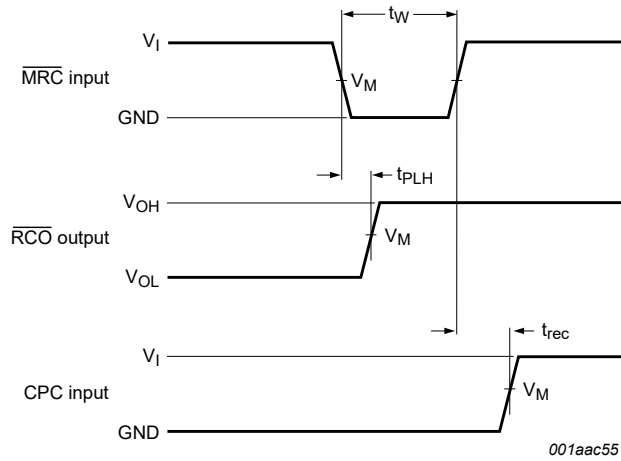


Table 8. Measurement points

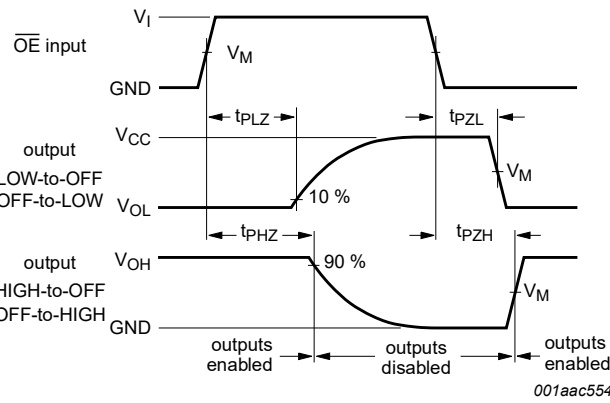
| Input | | Output |
|----------|-------------|-------------|
| V_I | V_M | V_M |
| V_{CC} | $0.5V_{CC}$ | $0.5V_{CC}$ |





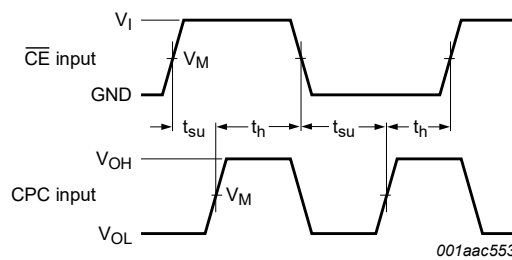
Measurement points are given in [Table 8](#).
 V_{OL} and V_{OH} are the typical output voltage levels that occur with the output load.

Fig. 10. Waveforms showing the propagation delays from the master reset counter input ($\overline{\text{MRC}}$) to output ($\overline{\text{RCO}}$), the $\overline{\text{MRC}}$ pulse width and recovery time



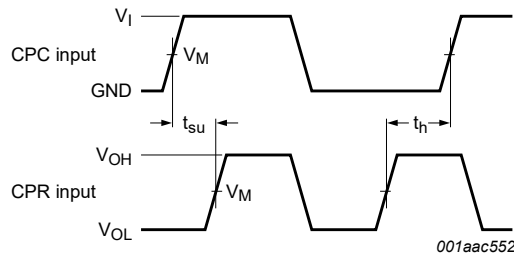
Measurement points are given in [Table 8](#).
 V_{OL} and V_{OH} are the typical output voltage levels that occur with the output load.

Fig. 11. Waveforms showing the 3-state enable and disable times



Measurement points are given in [Table 8](#).
 V_{OL} and V_{OH} are the typical output voltage levels that occur with the output load.

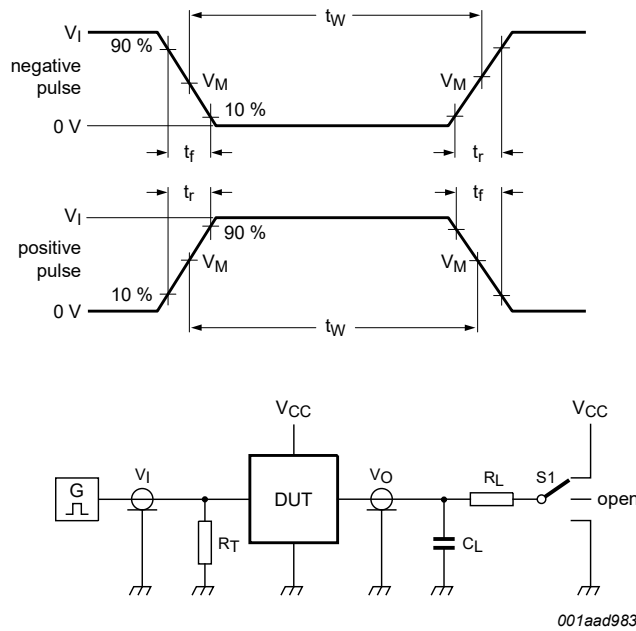
Fig. 12. Waveforms showing the set-up and hold times for the count enable input ($\overline{\text{CE}}$) to the counter clock input (CPC)



Measurement points are given in [Table 8](#).

V_{OL} and V_{OH} are the typical output voltage levels that occur with the output load.

Fig. 13. Waveforms showing the set-up and hold times for the counter clock input (CPC) to the register clock input (CPR)



Test data is given in [Table 9](#).

Definitions test circuit:

R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator;

C_L = Load capacitance including jig and probe capacitance;

R_L = Load resistance;

S1 = Test selection switch.

Fig. 14. Test circuit for measuring switching times

Table 9. Test data

| Supply voltage | Input | | Load | | Switch position | | |
|----------------|----------|------------|-------|--------------|--------------------|--------------------|--------------------|
| V_{CC} | V_I | t_r, t_f | C_L | R_L | t_{PHL}, t_{PLH} | t_{PZH}, t_{PHZ} | t_{PZL}, t_{PLZ} |
| 2.0 V to 6.0 V | V_{CC} | 6 ns | 50 pF | 1 k Ω | open | GND | V_{CC} |

11. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1

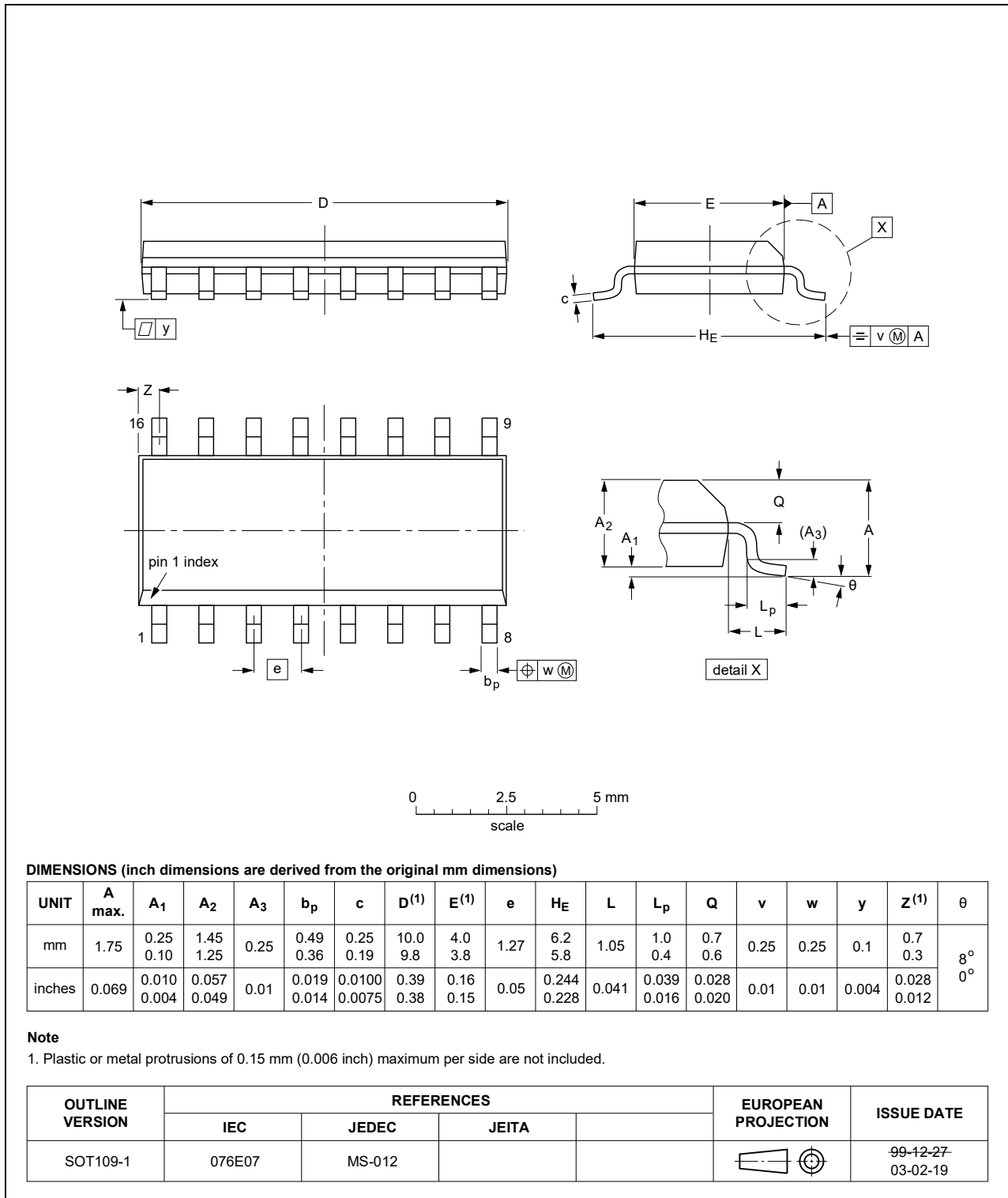


Fig. 15. Package outline SOT109-1 (SO16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



Fig. 16. Package outline SOT403-1 (TSSOP16)

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm

SOT763-1



Fig. 17. Package outline SOT763-1 (DHVQFN16)

12. Abbreviations

Table 10. Abbreviations

| Acronym | Description |
|---------|---|
| CDM | Charged Device Model |
| CMOS | Complementary Metal-Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| MM | Machine Model |

13. Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|----------------|--|--------------------|---------------|-------------|
| 74HC590 v.4 | 20220314 | Product data sheet | - | 74HC590 v.3 |
| Modifications: | <ul style="list-style-type: none"> The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. Section 2 updated. ESD CDM value changed from 2000 V to 1000 V (errata). Section 7: Derating values for P_{tot} total power dissipation updated. | | | |
| 74HC590 v.3 | 20160224 | Product data sheet | - | 74HC590 v.2 |
| Modifications: | <ul style="list-style-type: none"> Type number 74HC590N (SOT38-4) removed. | | | |
| 74HC590 v.2 | 20090428 | Product data sheet | - | 74HC590 v.1 |
| Modifications: | <ul style="list-style-type: none"> The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. Quick reference data incorporated in to Section 9 and Section 10. Added type number 74HC590N (DIP16 package) | | | |
| 74HC590 v.1 | 20050330 | Product data sheet | - | - |

14. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------|--------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <https://www.nexperia.com>.

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